

## Refine Search

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### Search Results -

Terms	Documents
L5 and (coupl\$3)	203

Database:

US Pre-Grant Publication Full-Text Database  
 US Patents Full-Text Database  
 US OCR Full-Text Database  
 EPO Abstracts Database  
 JPO Abstracts Database  
 Derwent World Patents Index  
 IBM Technical Disclosure Bulletins

Search:

L6






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### Search History

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DATE: Tuesday, March 15, 2005    [Printable Copy](#)    [Create Case](#)

**Set Name Query**  
side by side

**Hit Count Set Name**  
result set

*DB=USPT; PLUR=YES; OP=OR*

<u>L6</u>	L5 and (coupl\$3)	203	<u>L6</u>
<u>L5</u>	L4 and (board or PWB or PCB)	257	<u>L5</u>
<u>L4</u>	L3 and ground\$3	483	<u>L4</u>
<u>L3</u>	IEEE adj 1394	2547	<u>L3</u>
<u>L2</u>	L1 and ground\$3	10	<u>L2</u>
<u>L1</u>	link adj layer adj chip	17	<u>L1</u>

END OF SEARCH HISTORY